

SiC Schottky Barrier Diode

TRS16A65C

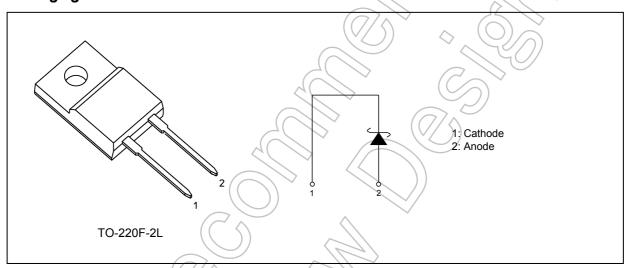
1. Applications

- · Power Factor Correction
- · Solar Inverters
- · Uninterruptible Power Supplies
- DC-DC Converters

2. Features

- (1) Forward DC current $I_{F(DC)} = 16 A$
- (2) Repetitive peak reverse voltage $V_{RRM} = 650 \text{ V}$

3. Packaging and Internal Circuit



4. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Repetitive peak reverse voltage	V_{RRM}		650	V
Forward DC current	I _{F(DC)}		16	Α
Forward pulse current	I _{FP}	(Note 1)	180	
I2t limit value	I2t	(Note 2)	32	A ² s
Junction temperature	Tj		175	ç
Storage temperature	T _{stg}		-55 to 175	
Isolation voltage(t = 1.0 s)	V _{dis}		2000	V
Mounting torque	TOR		0.6	N · m

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: $t = 100 \mu s$

Note 2: f = 50 Hz (half-sine wave t = 10 ms)

Start of commercial production



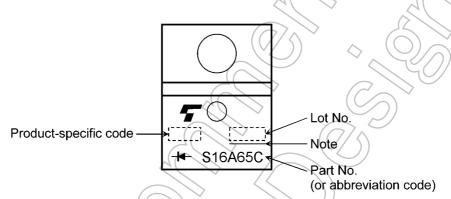
5. Thermal Characteristics

Characteristics	Symbol	Test Condition	Max	Unit
Thermal resistance (junction-to-case)	R _{th(j-c)}	_	3.33	°C/W
Thermal resistance (junction-to-ambient)	R _{th(j-a)}	_	62.5	

6. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	V _{FM} (1)	I _F = 8 A (pulse measurement)		1.27		V
	V _{FM} (2)	I _F = 16 A (pulse measurement)	$\langle \cdot \rangle$	1.5	1.7	
Repetitive peak reverse current	I _{RRM}	V _{RRM} = 650 V (pulse measurement)		0.4	90	μΑ
Junction capacitance	Cj	V _R = 650 V, f = 1 MHz	> -	88	_	pF

7. Marking



Note: A line under a Lot No. identifies the indication of product Labels.

[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

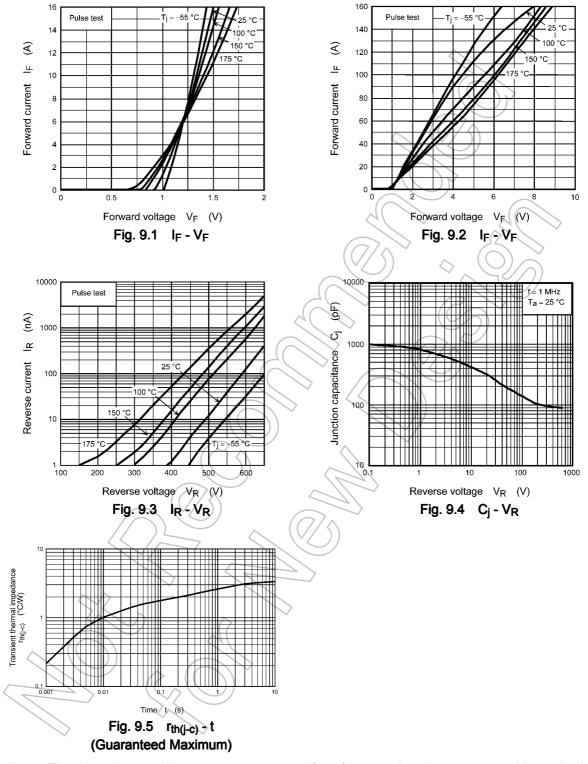
The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Abbreviation Code	Part Number
S16A65C	TRS16A65C

8. Usage Considerations

- (1) The absolute maximum ratings are rated values that must not be exceeded during operation, even for an instant. The following are the recommended general derating methods for designing a circuit board using this device.
 - V_{RRM}: V_{RRM} has a temperature coefficient of 0.1 %/°C.
 - Take this coefficient into account when designing a circuit board that will be operated in a low-temperature environment.
 - $I_{F(DC)}$: We recommend that the worst-case current be no greater than 80 % of the absolute maximum rating of $I_{F(DC)}$ and that the worst-case junction temperature, T_i , be kept below 140 °C.
 - $I_{FP}\hbox{:}\quad We\ recommend\ that\ the\ worst\mbox{-}case\ current\ be\ no\ greater\ than\ 80\ \%\ of\ the\ absolute\ maximum\ rating\ of\ I_{FP}\ and\ that\ the\ worst\mbox{-}case\ junction\ temperature,}\ T_j,\ be\ kept\ below\ 140\ ^\circ\text{C}.$
 - I2t: This rating specifies a non-repetitive limit value.This only applies to an abnormal operation, which seldom occurs during the lifespan of a device.
 - $T_j\text{:} \quad \text{Derate device parameters in proportion to this rating in order to ensure high reliability.}$ We recommend that the junction temperature (T_j) of a device be kept below 140 °C.
- (2) For other design considerations, see the Rectifiers databook or the Toshiba Semiconductor website.

9. Characteristics Curves (Note)

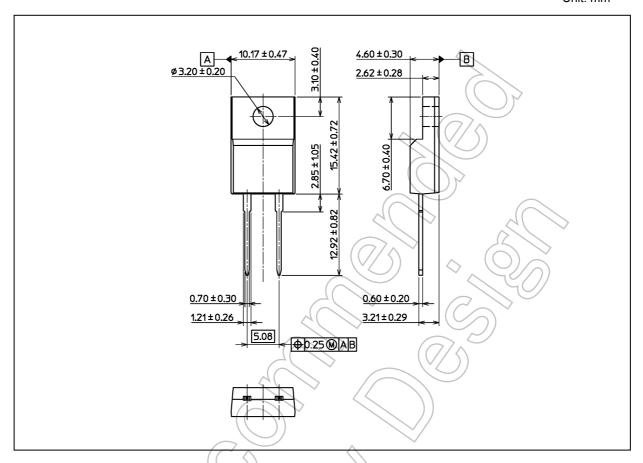


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

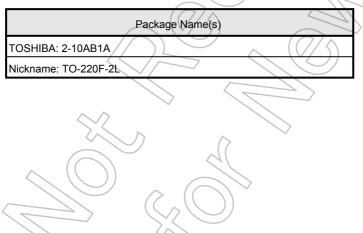


Package Dimensions

Unit: mm



Weight: 1.9 g (typ.)



Rev.1.0



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